

PCB stack-up

Project: microSD breakout board

Material: FR-4

Total Thickness: 0,716 mm

Name:	Layer:	Type:	Thickness:		Material:	Dk/εr:	Weight:	TG:
			mil	mm				
Silkscreen Top		Silkscreen	0,1	0,003				
Solder Mask Top		Solder Mask	0,4	0,010		3,8		
Copper Top	1	Copper	0,6	0,015			1 oz	
Dielectric		Core	26	0,665	KB-6164	4,8		135 °C
Copper Bottom	2	Copper	0,6	0,015			1 oz	
Solder Mask Bottom		Solder Mask	0,4	0,010		3,8		
Silkscreen Bottom		Silkscreen	0,1	0,003				